

## UTD452

Power MOSFET

N-CHANNEL ENHANCEMENT  
MODE

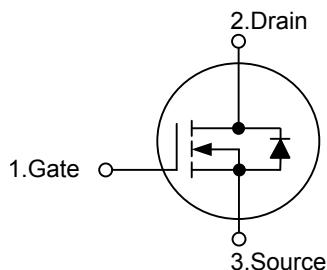
## ■ DESCRIPTION

The **UTD452** uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

## ■ FEATURES

- \*  $R_{DS(ON)} < 8.5\text{m}\Omega$  @  $V_{GS}=10\text{V}$
- \*  $R_{DS(ON)} < 14\text{m}\Omega$  @  $V_{GS}=4.5\text{V}$
- \* Low capacitance
- \* Low gate charge
- \* Fast switching capability
- \* Avalanche energy specified

## ■ SYMBOL



## ■ ORDERING INFORMATION

Ordering Number			Package	Pin Assignment			Packing
Normal	Lead Free	Halogen Free		1	2	3	
UTD452-TN3-R	UTD452L-TN3-R	UTD452G-TN3-R	TO-252	G	D	S	Tape Reel
UTD452-TN3-T	UTD452L-TN3-T	UTD452G-TN3-T	TO-252	G	D	S	Tube

UTD452L-TN3-R <ul style="list-style-type: none"> <li>(1)Packing Type</li> <li>(2)Package Type</li> <li>(3)Lead Plating</li> </ul>	<ul style="list-style-type: none"> <li>(1) R: Tape Reel, T: Tube</li> <li>(2) TN3: TO-252</li> <li>(3) G: Halogen Free, L: Lead Free, Blank: Pb/Sn</li> </ul>
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■ ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS		UNIT
Drain-Source Voltage		V <sub>DSS</sub>	25		V
Gate-Source Voltage		V <sub>GSS</sub>	±20		V
Continuous Drain Current	T <sub>C</sub> =25°C	I <sub>D</sub>	55		A
Pulsed Drain Current		I <sub>DM</sub>	100		A
Avalanche Current		I <sub>AR</sub>	30		A
Repetitive avalanche energy L=0.1mH		E <sub>AR</sub>	135		mJ
Power Dissipation	T <sub>C</sub> =25°C	P <sub>D</sub>	50		W
Junction Temperature		T <sub>J</sub>	+175		°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +175		°C

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by T<sub>J(MAX)</sub>

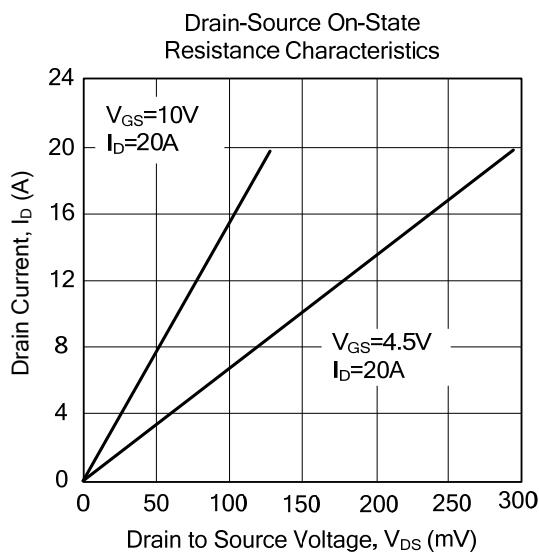
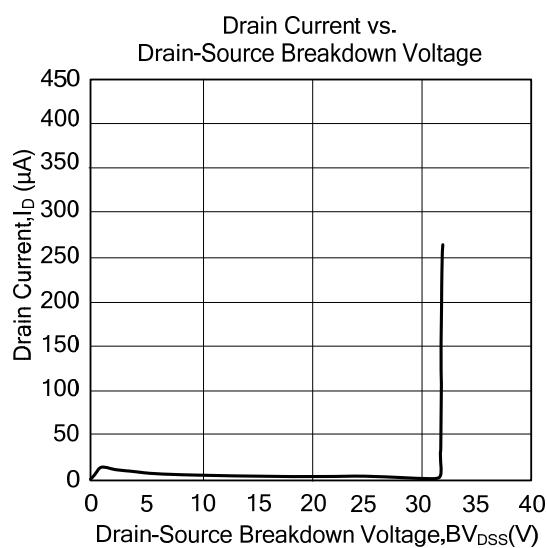
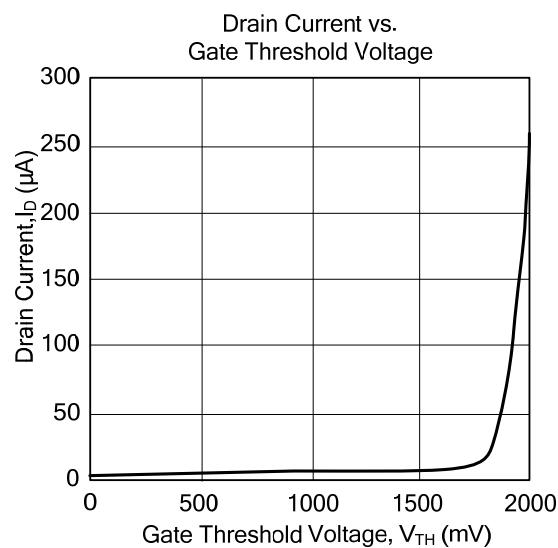
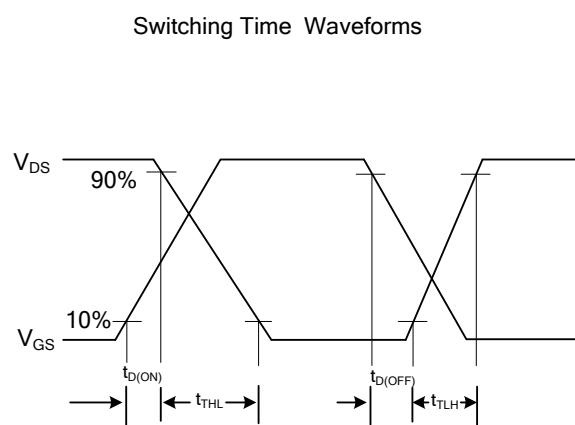
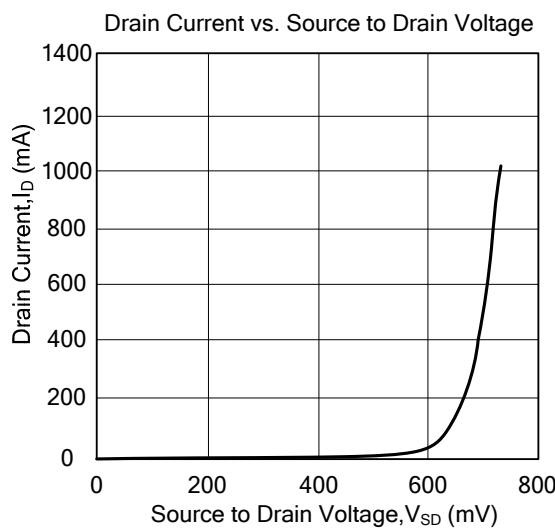
## ■ THERMAL DATA

PARAMETER		SYMBOL	MIN	TYP	MAX	UNIT
Junction-to-Ambient		θ <sub>JA</sub>		39	50	°C/W
Junction-to-Case		θ <sub>JC</sub>		2.5	3	°C/W

## ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	25			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.8	3	V
On State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> =5V, V <sub>GS</sub> =10V	100			A
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =30A		6.5	8.5	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A		11.5	14	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =10A		35		S
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =12.5V, V <sub>GS</sub> =0V, f=1MHz		1230	1476	pF
Output Capacitance	C <sub>OSS</sub>			315		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			190		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> =12.5V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A		26.4	32	nC
				13.5		
Gate Source Charge	Q <sub>GS</sub>			3.9		nC
Gate Drain Charge	Q <sub>GD</sub>			7.75		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =12.5V, R <sub>L</sub> =0.6Ω, R <sub>G</sub> =3Ω		6.5		ns
Turn-ON Rise Time	t <sub>R</sub>			10		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			22.7		ns
Turn-OFF Fall-Time	t <sub>F</sub>			6.2		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1A, V <sub>GS</sub> =0V		0.72	1	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>				55	A
Body Diode Reverse Recovery Time	t <sub>RR</sub>	I <sub>F</sub> =20A, dI/dt=100A/μs		23.06	27.5	ns
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	I <sub>F</sub> =20A, dI/dt=100A/μs		15.25		nC

■ TYPICAL CHARACTERISTICS



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